



**THE DATASHEET OF  
SDT8A100P5-7**





**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub>	100	V
Average Rectified Output Current	I <sub>O</sub>	8	A
Non-Repetitive Peak Forward Surge Current 8.3mS	I <sub>FSM</sub>	150	A

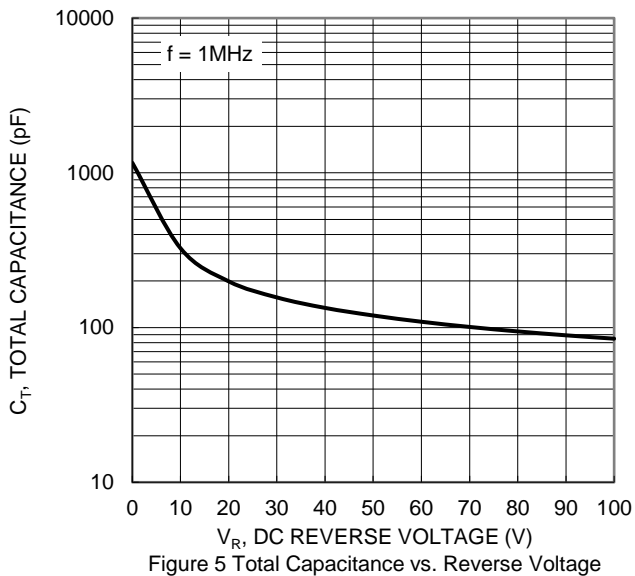
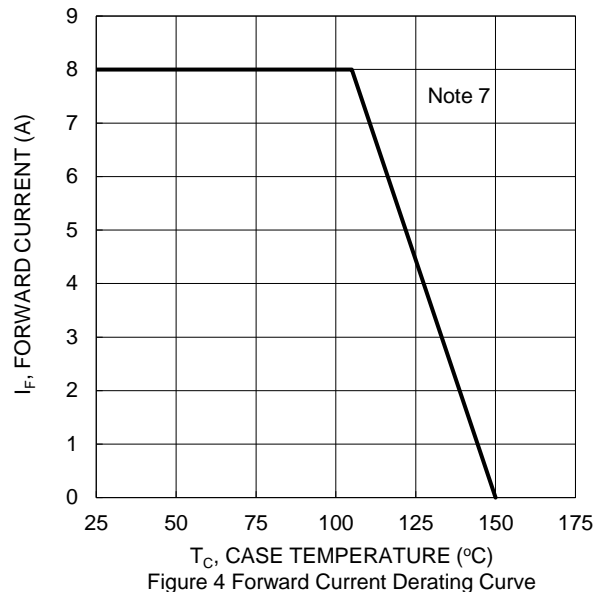
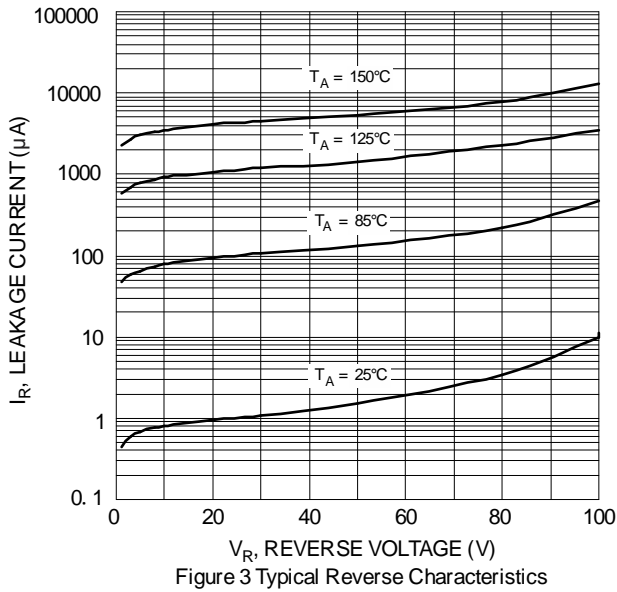
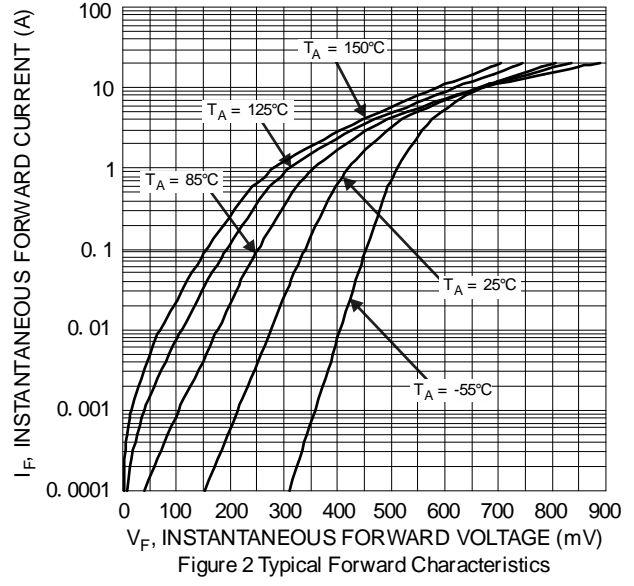
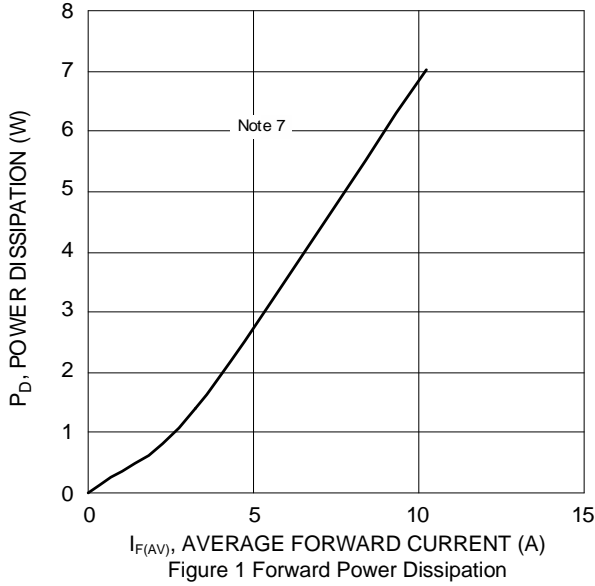
**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	R <sub>θJA</sub>	88	°C/W
Typical Thermal Resistance Junction to Ambient (Note 7)	R <sub>θJA</sub>	18	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R <sub>θJC</sub>	9	°C/W
Typical Thermal Resistance Junction to Case (Note 7)	R <sub>θJC</sub>	3	°C/W
Operating and Storage Temperature Range (Note 8)	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	—	—	0.70	V	I <sub>F</sub> = 8A, T <sub>J</sub> = +25°C
				0.66		I <sub>F</sub> = 8A, T <sub>J</sub> = +125°C
Leakage Current (Note 9)	I <sub>R</sub>	—	—	0.1	mA	V <sub>R</sub> = 100V, T <sub>J</sub> = +25°C
				20		V <sub>R</sub> = 100V, T <sub>J</sub> = +125°C

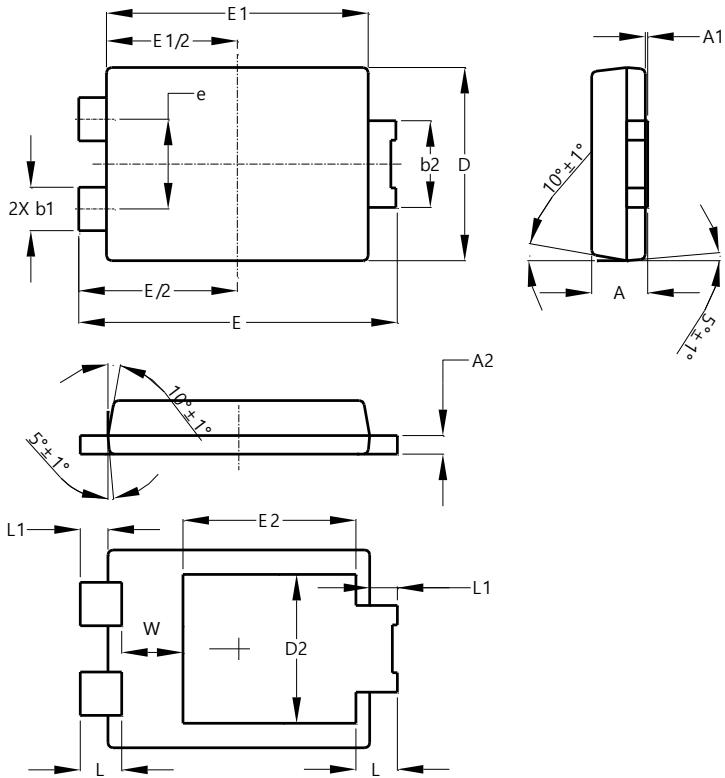
- Notes:
- 6. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  - 7. Aluminum 2inch x 2inch substrate PCB.
  - 8. The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D / dT_J < 1 / R_{\theta JA}$ .
  - 9. Short duration pulse test used to minimize self-heating effect.



**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5**

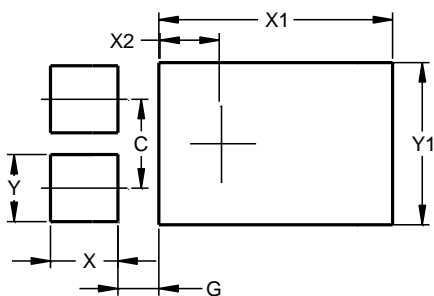


PowerDI5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.51
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**PowerDI5**



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.400
X1	4.860
X2	1.310
Y	1.390
Y1	3.360

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